

## ESPI Current Report

**Number:** 5/2020  
**Date:** 21 January 2020  
**Company:** XTPL S.A., a joint stock company with its registered office in Wrocław

**Topic:** Signing an agreement which starts evaluation of the XTPL technology for OSRAM

**Legal basis:** Article 17(1) MAR – inside information

**Contents of the Report:** The Management Board of XTPL S.A. (the “Company”, the “Issuer”) hereby announces that today it has signed an agreement which starts the process of evaluation of its technology with OSRAM Opto Semiconductors GmbH (the “Partner”) – a subsidiary of OSRAM – the global corporation from the lighting industry based in Munich, Germany (“OSRAM”).

The purpose of the agreement is to confirm parameters of the technology developed and commercialized by XTPL and to assess the possibility of implementing it in the process of manufacturing the Partner’s new generation products, specifically in respect of creating precise conductive structures for semi-conductors present in lighting devices.

Under the agreement signed, each party will be responsible for their respective costs, i.e. the Issuer – for the cost of printing on the Partner’s substrates, while the Partner – for the cost of preparing and sending the substrates, the cost of advanced analyses of the prints and evaluation of technological tests, as well as the cost of reference visits to the Issuer’s headquarters.

In the opinion of the Company’s Management Board the signing of the agreement which starts evaluation of technology for OSRAM is to be considered inside information because the potential client operates within an application field which is new to the Issuer (lighting industry) and is one of the global leaders of this market, so there are reasons to believe that implementation of the above agreement may have a significant impact on the Issuer’s future income position.

### Signatures of the Company’s representatives:

Maciej Adamczyk  
MANAGEMENT BOARD MEMBER